

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Seokkyu KANG</td> <td>06/24/2013</td> </tr> <tr> <td>Hyoni KIM</td> <td>06/24/2013</td> </tr> <tr> <td>Heeju CHANG</td> <td>06/24/2013</td> </tr> </tbody> </table>	Name	Execution Date	Seokkyu KANG	06/24/2013	Hyoni KIM	06/24/2013	Heeju CHANG	06/24/2013	
Name	Execution Date								
Seokkyu KANG	06/24/2013								
Hyoni KIM	06/24/2013								
Heeju CHANG	06/24/2013								
RECEIVING PARTY DATA									
Name:	LG Electronics Inc.								
Street Address:	20 Yeouido-dong, Yeongdeungpo-gu								
City:	Seoul								
State/Country:	KOREA, REPUBLIC OF								
Postal Code:	150-721								
PROPERTY NUMBERS Total: 1									
Property Type	Number								
Application Number:	29459109								
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NAME OF SUBMITTER:	Robert J. Goodell								
Signature:	/Robert J. Goodell/								
Date:	06/26/2013								
Total Attachments: 2 source=001082-7151-Assignment2#page3.tif source=001082-7151-Assignment2#page4.tif									

CH \$40.00 29459109

ATTORNEY DOCKET NO.:
SOLE/JOINT INVENTION
(U.S. Rights Only)

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:

FLIP COVER FOR MOBILE PHONE

for which I/WE executed an application for United States Letters Patent concurrently herewith; or filed an application for United States Letters Patent on ____, (Application No. ____); and

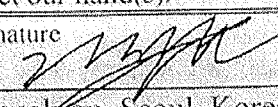
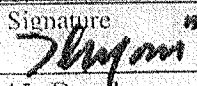
WHEREAS, LG ELECTRONICS INC., a corporation of Republic of Korea, whose post office address is 20 Yeouido-dong Yeongdeungpo-gu Seoul 150-721 Republic of Korea, (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to issue upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/WE, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, MY/OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/WE will, without further consideration, communicate with assignee, its successors and assigns, any facts known to ME/US respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/WE have empowered in the Declaration and Power of Attorney in this application, to insert here in parenthesis (Application No. _____, filed _____) the filing date and application number of said application when known.

IN TESTIMONY WHEREOF, I/WE have hereunto set our hand(s).

Full Name of Sole or First Assignor Seokkyu KANG	Assignor's Signature 	Date 2013. 6. 24
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Full Name of Second Assignor Hyoni KIM	Assignor's Signature 	Date 2013. 6. 24
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Names of additional inventors attached ☒ Yes ☐ No		

Full Name of Third Assignor Heeju CHANG	Assignor's Signature 	Date 2013. 6. 24
Address Deokpung-dong Byeoksan Blooming Apt. 108-1202, Deokpung 1-dong, Hamam-si, Gyeonggi-do, Korea		Citizenship Republic of Korea
Names of additional inventors attached ☐ Yes ☒ No		

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